

# GB10SLT12-220

# Silicon Carbide Power Schottky Diode

$V_{RRM}$	=	1200 V
$V_{F}$	=	1.5 V
I <sub>F</sub>	=	10 A
$\mathbf{Q}_{C}$	=	52 nC

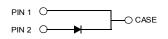
#### **Features**

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- · Superior surge current capability
- Positive temperature coefficient of V<sub>F</sub>
- · Extremely fast switching speeds
- Superior figure of merit Q<sub>C</sub>/I<sub>F</sub>

### **Package**

RoHS Compliant





TO - 220AC

#### **Advantages**

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

# **Applications**

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- · Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

#### Maximum Ratings at T<sub>i</sub> = 175 °C, unless otherwise specified

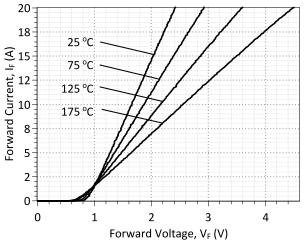
Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$		1200	V	
Continuous forward current	l <sub>F</sub>	T <sub>C</sub> ≤ 150 °C	10	Α	
RMS forward current	I <sub>F(RMS)</sub>	T <sub>C</sub> ≤ 150 °C	17	Α	
Surge non-repetitive forward current, Half Sine	1	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	65	۸	
Wave	I <sub>F,SM</sub>	$T_C$ = 150 °C, $t_P$ = 10 ms	55	Α	
Non-repetitive peak forward current	$I_{F,max}$	$T_C$ = 25 °C, $t_P$ = 10 $\mu$ s	280	Α	
l <sup>2</sup> t value	∫i² dt	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	21	A <sup>2</sup> -	
i t value		$T_{\rm C}$ = 150 °C, $t_{\rm P}$ = 10 ms	15	A <sup>2</sup> s	
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> = 25 °C	190	W	
Operating and storage temperature	$T_{j}$ , $T_{stg}$		-55 to 175	°C	

### Electrical Characteristics at T<sub>j</sub> = 175 °C, unless otherwise specified

Parameter	Cumbal	Conditions —		Values		11:4	
	Symbol			min.	typ.	max.	Unit
Diode forward voltage	V <sub>F</sub>	$I_F = 10 \text{ A}, T_j = 2$	I <sub>F</sub> = 10 A, T <sub>j</sub> = 25 °C		1.5	1.8	V
	VF	$I_F = 10 \text{ A}, T_j = 175 ^{\circ}\text{C}$		2.6	3.0	V	
Reverse current	ı	$V_R = 1200 \text{ V}, T_j = 25 ^{\circ}\text{C}$		5	50	μΑ	
	I <sub>R</sub>	$V_R = 1200 \text{ V}, T_i = 175 ^{\circ}\text{C}$		10	100		
Total capacitive charge	0	V <sub>R</sub> = 400 V			31		nC
	$Q_{C}$	$I_F \le I_{F,MAX}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	V <sub>R</sub> = 960 V		52		IIC
Switching time	4	$T_i = 175 ^{\circ}\text{C}$	V <sub>R</sub> = 400 V		< 25		no
	t <sub>s</sub>	V <sub>R</sub> = 960 V		< 25		ns	
Total capacitance	<u> </u>	$V_R = 1 \text{ V, f} = 1 \text{ MHz, T}_j = 25 ^{\circ}\text{C}$		490			
	С	$V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		45		pF	
		$V_R = 1000 \text{ V}, f = 1 \text{ MH}$	z, T <sub>i</sub> = 25 °C		33		

#### Thermal Characteristics

Thermal resistance, junction - case	$R_{thJC}$	0.8	°C/W
Mechanical Properties			
Mounting torque	M	0.6	Nm



**Figure 1: Typical Forward Characteristics** 

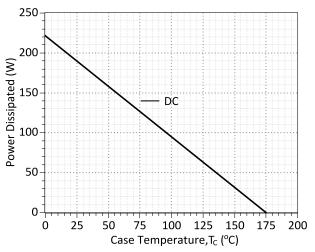


Figure 3: Power Derating Curve

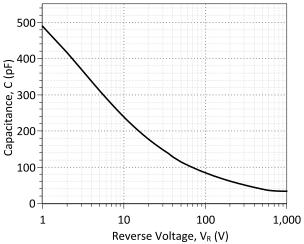


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

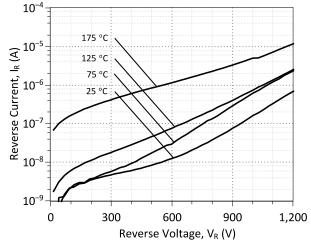


Figure 2: Typical Reverse Characteristics

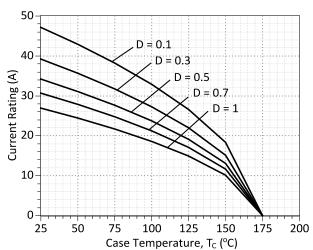


Figure 4: Current Derating Curves (D =  $t_P/T$ ,  $t_P$ = 400 µs) (Considering worst case  $Z_{th}$  conditions )

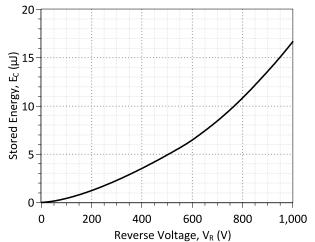


Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics



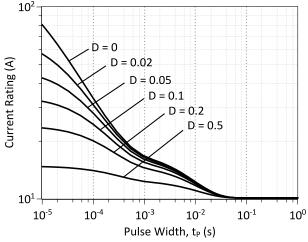


Figure 7: Current vs Pulse Duration Curves at  $T_c$  = 150 °C

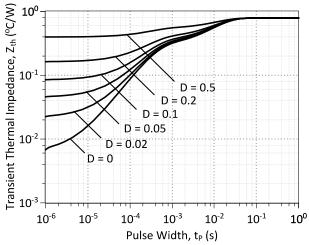
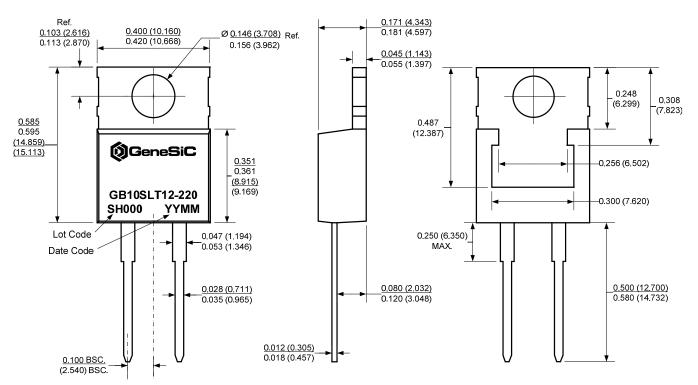


Figure 8: Transient Thermal Impedance

# **Package Dimensions:**

# TO-220AC PACKAGE OUTLINE



#### NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS





Revision History				
Date	Revision	Comments	Supersedes	
2013/11/12	4	Updated Electrical Characteristics		
2013/06/12	3	Updated Electrical Characteristics		
2012/12/18	2	Second generation update		
2012/05/22	1	Second generation release		
2010/12/14	0	Initial release		

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

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#### **SPICE Model Parameters**

Copy the following code into a SPICE software program for simulation of the GB10SLT12-220 device.

```
MODEL OF GeneSiC Semiconductor Inc.
    $Revision: 1.0
    $Date: 20-SEP-2013
                               $
    GeneSiC Semiconductor Inc.
    43670 Trade Center Place Ste. 155
    Dulles, VA 20166
    http://www.genesicsemi.com/index.php/sic-products/schottky
   COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
    ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB10SLT12-220 SPICE Model
.SUBCKT GB10SLT12 ANODE KATHODE
D1 ANODE KATHODE GB10SLT12 SCHOTTKY
D2 ANODE KATHODE GB10SLT12 PIN
.MODEL GB10SLT12 SCHOTTKY D
                                  0.0736
     4.55E-15 RS
+ IS
+ N
                                   1000
                         IKF
         1
        1.2
+ EG
                        XTI
                                   -2
+ TRS1 0.0054347826 TRS2
+ CJO 6.40E-10 VJ
                                   2.71739E-05
                                   0.469
+ M
         1.508
                        FC
                                   0.5
+ TT
        1.00E-10
1.00E-03
                        BV
                                    1200
+ IBV
                        VPK
                                   1200
+ IAVE
         10
                                   SiC Schottky
                          TYPE
+ MFG GeneSiC_Semi
.MODEL GB10SLT12 PIN D
         1.54E-22
                                   0.19
+ IS
                        RS
        -0.004
+ TRS1
                        N
                                    3.941
+ EG
         3.23
                         IKF
                                   19
+ XTI
         0
                        FC
                                    0.5
+ TT
          0
                         BV
                                    1200
+ IBV
+ IAVE
         1.00E-03
                        VPK
                                    1200
          10
                          TYPE
                                    SiC PiN
.ENDS
```

\* End of GB10SLT12-220 SPICE Model